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# **HD74AC174**

# Hex D-Type Flip-Flop with Master Reset

REJ03D0256-0200Z (Previous ADE-205-376 (Z)) Rev.2.00 Jul.16.2004

#### **Description**

The HD74AC174 is a high-speed hex D flip-flop. The device is used primarily as a 6-bit edge-triggered storage register. The information on the D inputs is transferred to storage during the Low-to-High clock transition. The device has a Master Reset to simultaneously clear all flip-flops.

#### **Features**

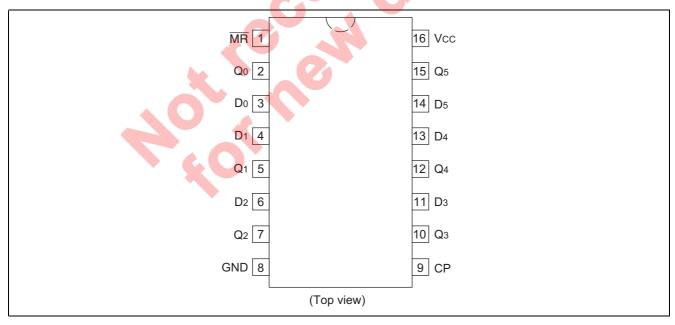
- Outputs Source/Sink 24 mA
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74AC174FPEL	SOP-16 pin (JEITA)	FP-16DAV	FP	EL (2,000 pcs/reel)
HD74AC174RPEL	SOP-16 pin (JEDEC)	FP-16DNV	RP	EL (2,500 pcs/reel)

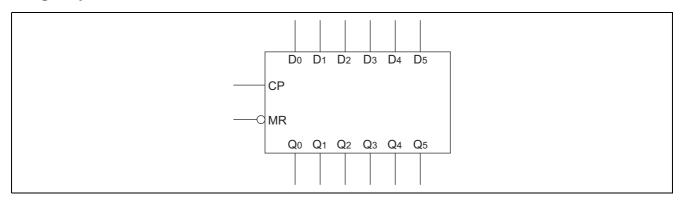
Notes: 1. Please consult the sales office for the above package availability.

2. The packages with lead-free pins are distinguished from the conventional products by adding V at the end of the package code.

### Pin Arrangement



#### **Logic Symbol**



#### **Pin Names**

 $\begin{array}{ll} D_0 \ to \ D_5 & Data \ Inputs \\ \hline CP & Clock \ Pulse \ Input \\ \hline MR & Master \ Reset \ Input \\ Q_0 \ to \ Q_5 & Outputs \end{array}$ 

#### **Functional Description**

The HD74AC174 consists of six edge-triggered D flip-flops with individual D inputs and Q outputs. The Clock (CP) and Master Reset ( $\overline{\text{MR}}$ ) are common to all flip-flops. Each D input's state is transferred to the corresponding flip-flops's output following the Low-to-High Clock (CP) transition. A Low input to the Master Reset ( $\overline{\text{MR}}$ ) will force all outputs Low independent of Clock or Data inputs. The HD74AC174 is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

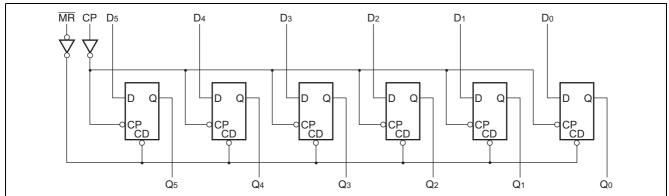
#### **Truth Table**

	Output		
MR	СР	D	Q
L	X	X	L
Н	5	Н	Н
Н		L	L
Н		Х	Q

H : High Voltage LevelL : Low Voltage LevelX : Immaterial

: Low-to-High Transition of Clock

## **Logic Diagram**



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V <sub>cc</sub>	-0.5 to 7	V	
DC input diode current	I <sub>IK</sub>	-20	mA	$V_1 = -0.5V$
		20	mA	$V_I = Vcc+0.5V$
DC input voltage	V <sub>I</sub>	-0.5 to Vcc+0.5	V	
DC output diode current	I <sub>OK</sub>	-50	mA	$V_{O} = -0.5V$
		50	mA	$V_O = Vcc+0.5V$
DC output voltage	Vo	-0.5 to Vcc+0.5	V	
DC output source or sink current	I <sub>o</sub>	±50	mA	
DC V <sub>CC</sub> or ground current per output pin	I <sub>CC</sub> , I <sub>GND</sub>	±50	mA	
Storage temperature	Tstg	-65 to +150	°C	

# **Recommended Operating Conditions**

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V <sub>cc</sub>	2 to 6	V	
Input and output voltage	$V_{I}, V_{O}$	0 to V <sub>CC</sub>	V	
Operating temperature	Та	-40 to +85	°C	
Input rise and fall time	tr, tf	8	ns/V	$V_{CC} = 3.0V$
(except Schmitt inputs)				$V_{CC} = 4.5 \text{ V}$
$V_{IN}$ 30% to 70% $V_{CC}$				V <sub>CC</sub> = 5.5 V

#### **DC Characteristics**

Item	Sym- bol	Vcc (V)	7	Γa = 25°(		Ta = -40 to +85°C		Unit	Condition
			min.	typ.	max.	min.	max.		
Input Voltage	V <sub>IH</sub>	3.0	2.1	1.5		2.1	—	V	$V_{OUT} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$
		4.5	3.15	2.25		3.15	_		
		5.5	3.85	2.75		3.85	_		
	V <sub>IL</sub>	3.0	—	1.50	0.9	_	0.9		$V_{OUT} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$
		4.5	_	2.25	1.35	_	1.35		
		5.5	_	2.75	1.65	_	1.65		
Output voltage	$V_{OH}$	3.0	2.9	2.99	_	2.9	_	V	$V_{IN} = V_{IL}$ or $V_{IH}$
		4.5	4.4	4.49	_	4.4	_		$I_{OUT} = -50 \mu A$
		5.5	5.4	5.49	_	5.4	_		
		3.0	2.58	_	_	2.48	_		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} = -12 \text{ mA}$
		4.5	3.94	_	_	3.80	_		$I_{OH} = -24 \text{ mA}$
		5.5	4.94	_	_	4.80	_		$I_{OH} = -24 \text{ mA}$
	V <sub>OL</sub>	3.0	_	0.002	0.1	_	0.1		$V_{IN} = V_{IL}$ or $V_{IH}$
		4.5	_	0.001	0.1	_	0.1		I <sub>OUT</sub> = 50 μA
		5.5	_	0.001	0.1	_	0.1		
		3.0	_	_	0.32	_	0.37		$V_{IN} = V_{IL}$ or $V_{IH}$ $I_{OL} = 12 \text{ mA}$
		4.5	_	_	0.32	- 4	0.37		$I_{OL} = 24 \text{ mA}$
		5.5	_	_	0.32	-	0.37		$I_{OL} = 24 \text{ mA}$
Input leakage	I <sub>IN</sub>	5.5	_	_	±0.1	-	±1.0	μΑ	V <sub>IN</sub> = V <sub>CC</sub> or GND
current									
Dynamic output	I <sub>OLD</sub>	5.5	_	_		86		mΑ	V <sub>OLD</sub> = 1.1 V
current*	I <sub>OHD</sub>	5.5	_	_		<b>-75</b>		mΑ	V <sub>OHD</sub> = 3.85 V
Quiescent supply current	I <sub>cc</sub>	5.5	_	7	8.0		80	μΑ	$V_{IN} = V_{CC}$ or ground

<sup>\*</sup>Maximum test duration 2.0 ms, one output loaded at a time.

## AC Characteristics: HD74AC174

			Ta = +25°C C <sub>L</sub> = 50 pF				C to +85°C 50 pF	
Item	Symbol	V <sub>cc</sub> (V)*1	Min	Тур	Max	Min	Max	Unit
Maximum clock	f <sub>max</sub>	3.3	90	100	_	70	_	MHz
frequency		5.0	100	125	_	100	_	
Propagation delay	t <sub>PLH</sub>	3.3	1.0	9.0	11.5	1.0	12.5	ns
CP to Q <sub>n</sub>		5.0	1.0	6.0	8.5	1.0	9.5	
Propagation delay	t <sub>PHL</sub>	3.3	1.0	8.5	11.0	1.0	12.0	ns
CP to Q <sub>n</sub>		5.0	1.0	6.0	8.0	1.0	9.0	
Propagation delay	t <sub>PHL</sub>	3.3	1.0	9.0	11.5	1.0	12.5	ns
$\overline{MR}$ to $Q_n$		5.0	1.0	7.0	9.0	1.0	10.5	

Note: 1. Voltage Range 3.3 is 3.3 V  $\pm$  0.3 V Voltage Range 5.0 is 5.0 V  $\pm$  0.5 V

## AC Operating Requirements: HD74AC174

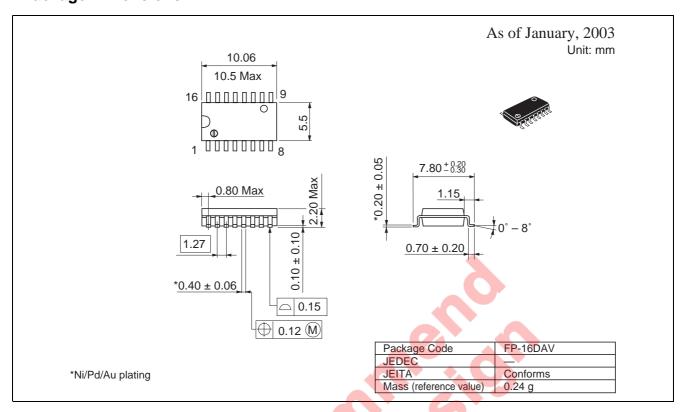
			Ta = +25°C C <sub>L</sub> = 50 pF		Ta = -40°C to +85°C C <sub>L</sub> = 50 pF	
Item	Symbol	V <sub>cc</sub> (V)*1	Тур	Guarantee	d Minimum	Unit
Setup time, HIGH or LOW	t <sub>su</sub>	3.3	2.5	6.5	7.0	ns
D <sub>n</sub> to CP		5.0	2.0	5.0	5.5	
Hold time, HIGH or LOW	t <sub>h</sub>	3.3	1.0	3.0	3.0	ns
D <sub>n</sub> to CP		5.0	0.5	3.0	3.0	
MR pulse width, LOW	t <sub>w</sub>	3.3	1.0	5.5	7.0	ns
		5.0	1.0	5.0	5.0	
CP pulse width	t <sub>w</sub>	3.3	1.0	5.5	7.0	ns
		5.0	1.0	5.0	5.0	
Recovery time	t <sub>rec</sub>	3.3	0	2.5	2.5	ns
MR to CP		5.0	0	2.0	2.0	

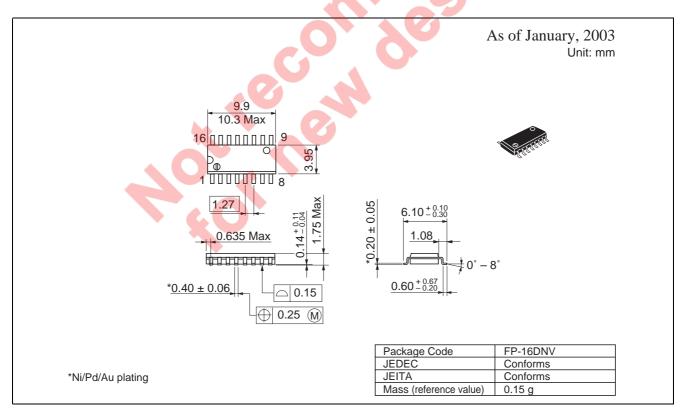
Note: 1. Voltage Range 3.3 is 3.3 V  $\pm$  0.3 V Voltage Range 5.0 is 5.0 V  $\pm$  0.5 V

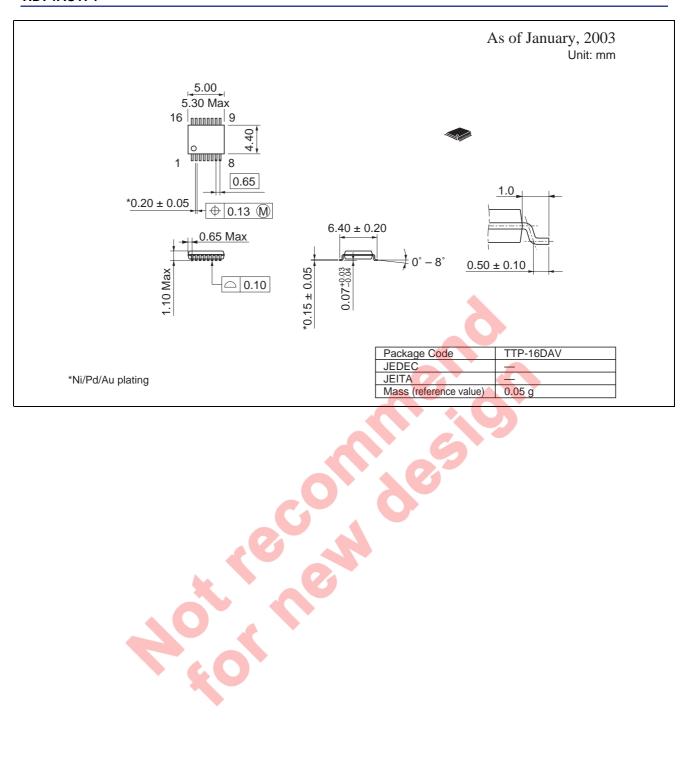
## Capacitance

Item	Symbol	Тур	Unit	Condition
Input capacitance	C <sub>IN</sub>	4.5	pF	V <sub>CC</sub> = 5.5 V
Power dissipation capacitance	$C_{PD}$	85.0	pF	$V_{CC} = 5.0 \text{ V}$
			96	

#### **Package Dimensions**







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